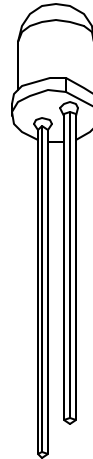
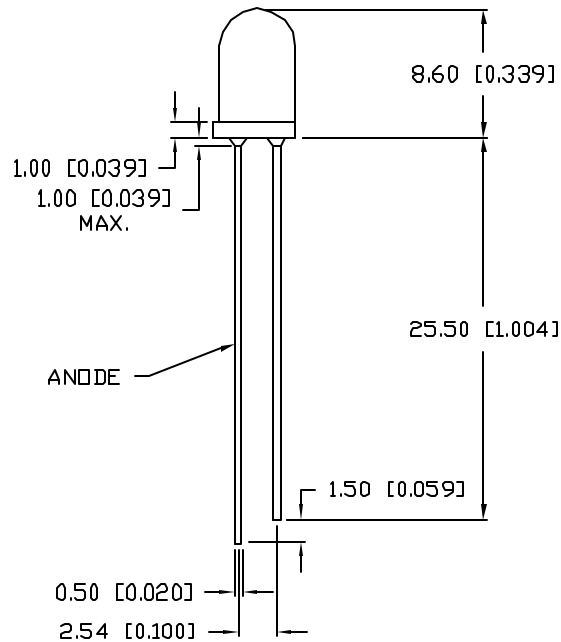
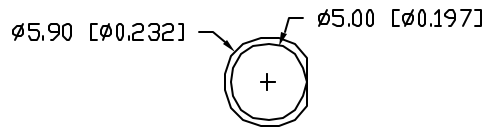


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REV.



ELECTRO-OPTICAL CHARACTERISTICS  $T_A=25^\circ\text{C}$

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH			-		nm	
FORWARD VOLTAGE	$V_f$		3.2	4.0	V	$I_f=20\text{mA}$
REVERSE VOLTAGE	$V_r$	5			V	$I_r=10\mu\text{A}$
AXIAL INTENSITY(*1)	$I_v$	900	2200		mcd	$I_f=20\text{mA}$
CHROMATICITY	X		0.22			$I_f=20\text{mA}$
COORDINATES(*2)	Y		0.10			
VIEWING ANGLE			20		2x theta	
EMITTED COLOR:	PURPLE					
EPOXY LENS FINISH:	WATER CLEAR					

\*1. AXIAL INTENSITY TESTING CONDITION: 550nm WAVELENGTH.  
\*2. THE ICI STANDARD COLORIMETRIC SYSTEM.

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	SYMBOL	MAX	UNITS
PULSE FORWARD CURRENT	$I_p$	100*	mA
STEADY CURRENT	$I_F$	30	mA
POWER DISSIPATION	$P_D$	120	mW
OPERATING TEMP.	$T_{OPR}$	-40 TO +85	°C
STORAGE TEMP.	$T_{STG}$	-40 TO +85	°C
SOLDERING TEMP.		+260	°C
2.0mm FROM BODY			3 SEC. MAX

\*DUTY 1/10 PULSE WIDTH 10ms

CAUTION: STATIC SENSITIVE DEVICE  
FOLLOW PROPER E.S.D. HANDLING PROCEDURES  
WHEN WORKING WITH THIS PART.



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\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005), LEAD SIZE=±0.08 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN= <sup>+0.00</sup> <sub>-0.00</sub> DECIMAL PRECISION, MAX.= <sup>+0.00</sup> <sub>-0.00</sub> DECIMAL PRECISION

REV.

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T-5mm PURPLE LED,  
WATER CLEAR LENS.

RELIABILITY NOTE  
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: JN	CHECKED BY:	APPROVED BY:	DATE: 02.26.08
			PAGE: 1 OF 1
			SCALE: N/A